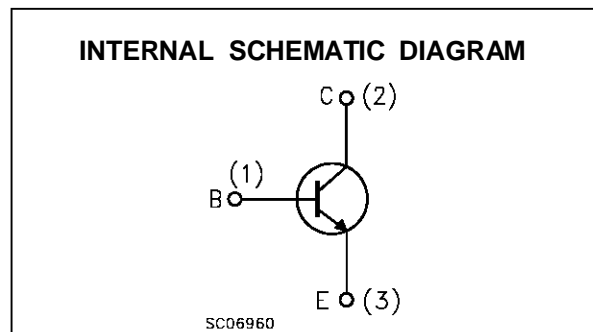
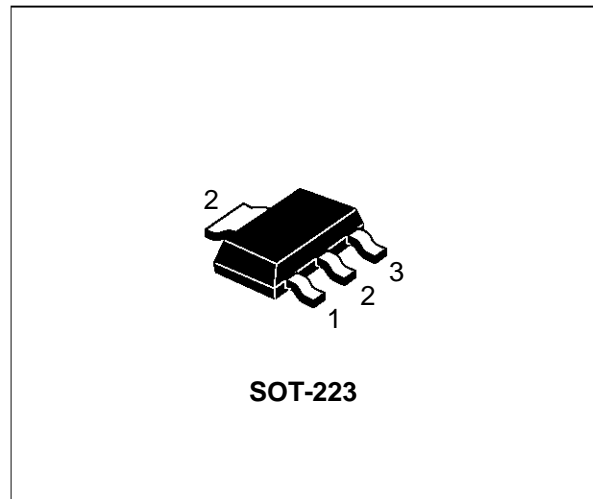


MEDIUM POWER AMPLIFIER

ADVANCE DATA

- SILICON EPITAXIAL PLANAR NPN TRANSISTORS
- MINIATURE PLASTIC PACKAGE FOR APPLICATION IN SURFACE MOUNTING CIRCUITS
- GENERAL PURPOSE MAINLY INTENDED FOR USE IN MEDIUM POWER INDUSTRIAL APPLICATION AND FOR AUDIO AMPLIFIER OUTPUT STAGE
- PNP COMPLEMENTS ARE STZT5400 AND STZT5401 RESPECTIVELY



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value		Unit
		STZT5550	STZT5551	
V_{CBO}	Collector-Base Voltage ($I_E = 0$)	160	180	V
V_{CEO}	Collector-Emitter Voltage ($I_B = 0$)	140	160	V
V_{EBO}	Emitter-Base Voltage ($I_C = 0$)	6		V
I_C	Collector Current	0.6		A
P_{tot}	Total Dissipation at $T_c = 25^\circ\text{C}$	1.5		W
T_{stg}	Storage Temperature	-65 to 150		$^\circ\text{C}$
T_j	Max. Operating Junction Temperature	150		$^\circ\text{C}$

STZT5550/STZT5551

THERMAL DATA

$R_{thj-amb}$	Thermal Resistance Junction-Ambient	Max	62.5	$^{\circ}\text{C}/\text{W}$
$R_{thj-tab}$	Thermal Resistance Junction-Collector Tab	Max	8	$^{\circ}\text{C}/\text{W}$

• Mounted on a ceramic substrate area = 30 x 35 x 0.7 mm

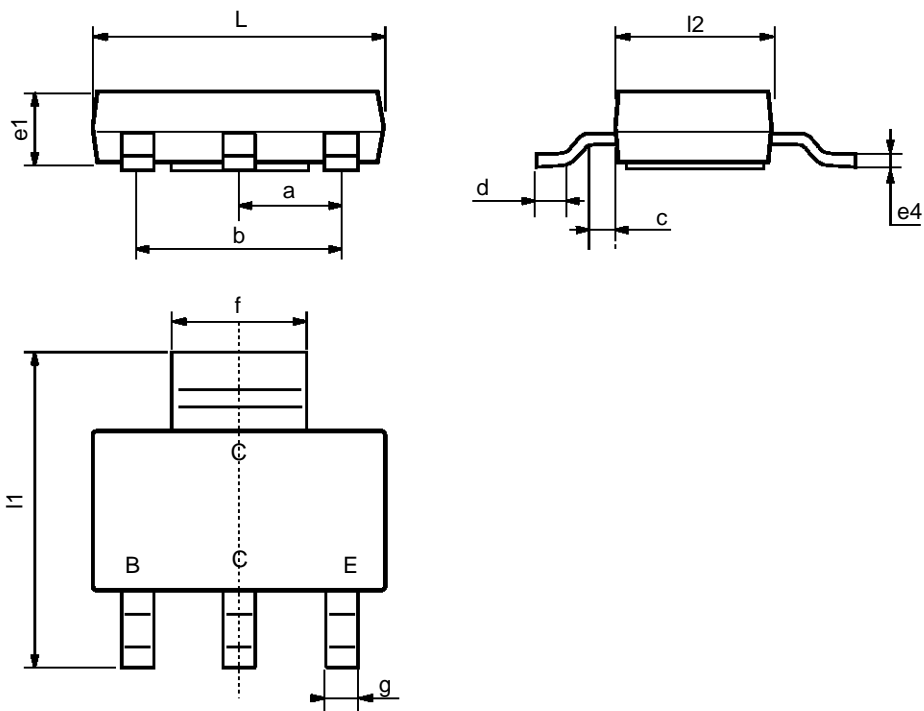
ELECTRICAL CHARACTERISTICS ($T_{case} = 25^{\circ}\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I_{CBO}	Collector Cut-off Current ($I_E = 0$)	$V_{CB} = 100\text{ V}$ for STZT5550 $V_{CB} = 120\text{ V}$ for STZT5551			100 50	nA nA
I_{EBO}	Emitter Cut-off Current ($I_E = 0$)	$V_{EB} = 4\text{ V}$			50	nA
$V_{(BR)CBO}$	Collector-Base Breakdown Voltage ($I_E = 0$)	$I_C = 100\ \mu\text{A}$ for STZT5550 for STZT5551	160 180			V V
$V_{(BR)CEO}^*$	Collector-Emitter Breakdown Voltage ($I_B = 0$)	$I_C = 1\text{ mA}$ for STZT5550 for STZT5551	140 160			V V
$V_{(BR)EBO}$	Emitter-Base Breakdown Voltage ($I_C = 0$)	$I_C = 10\ \mu\text{A}$	6			V
$V_{CE(sat)}^*$	Collector-Emitter Saturation Voltage	$I_C = 10\text{ mA}$ $I_B = 1\text{ mA}$ $I_C = 50\text{ mA}$ $I_B = 5\text{ mA}$ for STZT5550 for STZT5551			0.15 0.25 0.2	V V V
$V_{BE(sat)}^*$	Base-Emitter Saturation Voltage	$I_C = 10\text{ mA}$ $I_B = 1\text{ mA}$ $I_C = 50\text{ mA}$ $I_B = 5\text{ mA}$ for STZT5550 for STZT5551			1 1.2 1	V V V
h_{FE}^*	DC Current Gain	for STZT5550 $I_C = 1\text{ mA}$ $V_{CE} = 5\text{ V}$ $I_C = 10\text{ mA}$ $V_{CE} = 5\text{ V}$ $I_C = 50\text{ mA}$ $V_{CE} = 5\text{ V}$ for STZT5551 $I_C = 1\text{ mA}$ $V_{CE} = 5\text{ V}$ $I_C = 10\text{ mA}$ $V_{CE} = 5\text{ V}$ $I_C = 50\text{ mA}$ $V_{CE} = 5\text{ V}$	60 60 20 80 80 30		120 300	
f_{ie}	Small Signal Current Gain	$I_C = 1\text{ mA}$ $V_{CE} = 10\text{ V}$ $f = 1\text{ KHz}$	50		200	
f_T	Transition Frequency	$I_C = 10\text{ mA}$ $V_{CE} = 10\text{ V}$ $f = 100\text{ MHz}$	100		300	MHz
C_{CBO}	Collector-Base Capacitance	$I_E = 0$ $V_{CB} = 10\text{ V}$ $f = 1\text{ MHz}$			6	pF
C_{EBO}	Emitter-Base Capacitance	$I_C = 0$ $V_{EB} = 0.5\text{ V}$ $f = 1\text{ MHz}$			20	pF
F	Noise Figure	$f = 1\text{ KHz}$ $\Delta F = 200\text{ Hz}$ $R_G = 1\text{ K}\Omega$ $I_C = 0.25\text{ mA}$ $V_{CE} = 5\text{ V}$		6		dB

* Pulsed: Pulse duration = 300 μs , duty cycle $\leq 1.5\%$

SOT223 MECHANICAL DATA

DIM.	mm			mils		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
a	2.27	2.3	2.33	89.4	90.6	91.7
b	4.57	4.6	4.63	179.9	181.1	182.3
c	0.2	0.4	0.6	7.9	15.7	23.6
d	0.63	0.65	0.67	24.8	25.6	26.4
e1	1.5	1.6	1.7	59.1	63	66.9
e4			0.32			12.6
f	2.9	3	3.1	114.2	118.1	122.1
g	0.67	0.7	0.73	26.4	27.6	28.7
l1	6.7	7	7.3	263.8	275.6	287.4
l2	3.5	3.5	3.7	137.8	137.8	145.7
L	6.3	6.5	6.7	248	255.9	263.8



P008B

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